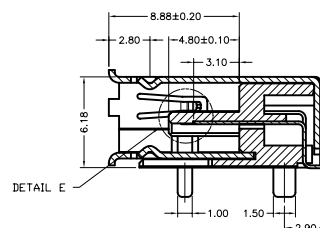
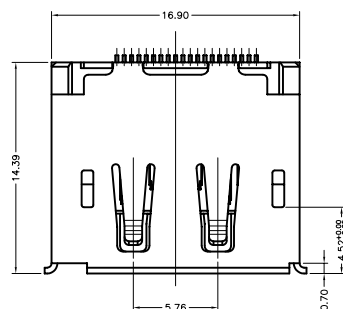


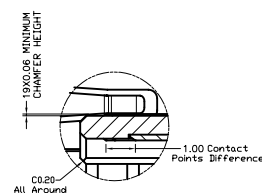
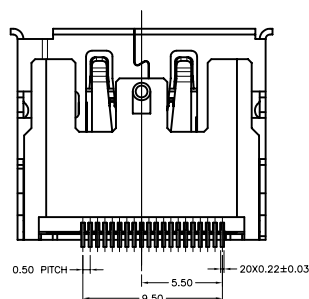
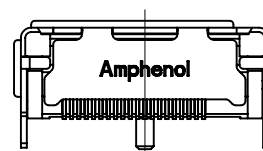
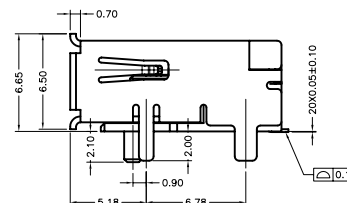
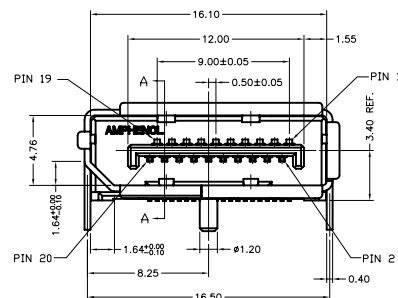
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REVISIONS				
SYM	ECN	DESCRIPTION	DATE	APPROVED
1	HK5456	New Release	11/13/08	IP

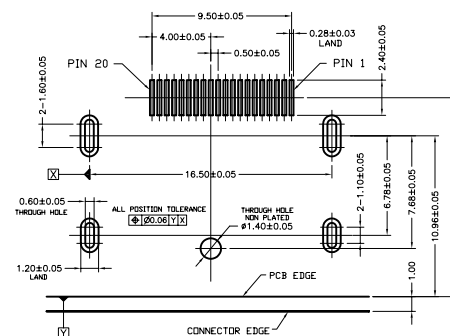
Customer Drawing



SECTION A-A



DETAIL E
SCALE 2:1



RECOMMENDED PCB LAYOUT (THK=1.6+/-0.15mm)

NOTES:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE PLASTIC UL94V-0. BLACK.

CONTACT: PHOSPHOR BRONZE ,THICKNESS=0.20mm

SHIELD: BRASS OR SPCC, THICKNESS=0.4mm

2.FINISH:

CONTACT: REFER TO P/N SYSTEM ON MATING AREA

1.27~2.54μm NICKEL UNDERPLATE OVERALL

2.54~5.08 μ m PURE TIN ON SOLDER TAIL

SHIELD: REFER TO P/N SYSTEM

3.ELECTRICAL SPECIFICATION:

CURRENT RATING: 0.5A

CONTACT RESISTANCE: 30mΩ MAX

INSULATOR RESISTANCE: 100M Ω MIN(UNMATED) 10M Ω MIN(MATED)

DIELECTRIC WITHSTANDING VOLTAGE: 500 V AC(UNMATED) 300 V AC(MATED)

4. ORDER P/N SYSTEM: DP-F201-001-X-X-XX

MATING AREA PLATING

1- 0.76um MIN Au.

2- 0.38um MIN Au.
A- Gold FLASH

A- Gold FLASH

PACKING METHOD:

N/A- PACKING IN TRAY.

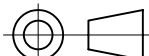
TR- PACKING IN TAPE AND REEL.

SHELL PLATING:

— SHELL PLATING:
1- GOLD FLASH PLATED.

2- SOLDERABLE

3- TIN PLATED.
4- SOLDERABLE BLACK NICKEL PLATED.

ITEM	PART	NO.	REQ'D	DESCRIPTION
PARTS LIST				
UNLESS OTHERWISE SPECIFIED TOLERANCES U.S. METRIC .X +/- ±0.50 .XX +/- ±0.25 .XXX +/- ±0.10 FRACTIONS +/- ANGLES +/-			APPROVAL DATE DRAWN Drack 11/13/08 CHECKED Tony 11/13/08 CHECKED	
FOR MATERIALS AND FINISHES SEE NOTES REMOVE SHARP EDGES DIMENSIONS U.S. INCHES— (METRIC) (MM)			DRAWING FILE : Drawing/DP/CDPF201001XXXX TITLE DISPLAYPORT R/A SMT RECEPTACLE (SHELL DIP)	
ANGLE OF PROJECTION 			SIZE DRAWING NO. REV. A3 C DP-F201-001-X-X-XX 1	
SCALE NONE			SHEET 1 OF 1	